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(71) Applicant(s):

DENKA COMPANY LIMITED [JP/JP]; 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 1038338 (JP) (*for all designated states*)

(72) Inventor(s):

WADA, Kosuke; c/o Denka Company Limited Omuta Plant, 1, Shinkai-machi, Omuta-shi, Fukuoka 8368510 (JP)

KANEKO, Masahide; c/o Denka Company Limited Omuta Plant, 1, Shinkai-machi, Omuta-shi, Fukuoka 8368510 (JP)

NONOGAKI, Ryoza; c/o Denka Company Limited Omuta Plant, 1, Shinkai-machi, Omuta-shi, Fukuoka 8368510 (JP)

(74) Agent(s):

TAGUCHI, Masahiro; DAIYA PATENT OFFICE, Toranomom ES Bldg. 8F., 25-2, Toranomom 3-chome, Minato-ku, Tokyo 1050001 (JP)

(54) Title (EN): LAYERED BODY

(54) Title (FR): CORPS STRATIFIÉ

(54) Title (JA): 積層体

(57) Abstract:

(EN): This layered body has a silicone resin composition layer comprising a cured silicone resin composition containing a silicone resin and an inorganic filler, and adjacent to the silicone resin composition layer, a base material resin layer containing a resin having a glass transition point of 200°C or higher, the content of the inorganic filler in the silicone resin composition layer being 60 to 80% by volume.

(FR): L'invention concerne un corps stratifié ayant une couche de composition de résine de silicone comprenant une composition de résine de silicone durcie contenant une résine de silicone et une charge inorganique, et adjacente à la couche de composition de résine de silicone, une couche de résine de matériau de base contenant une résine ayant un point de transition vitreuse de 200 °C ou plus, la teneur de la charge inorganique dans la couche de composition de résine de silicone étant de 60 à 80 % en volume.

(JA): シリコン樹脂及び無機フィラーを含有するシリコン樹脂組成物を硬化してなるシリコン樹脂組成物層と、シリコン樹脂組成物層に隣接し、ガラス転移点が200°C以上である樹脂を含む基材樹脂層と、を有し、シリコン樹脂組成物層中に上記無機フィラーを60～80体積%含有する、積層体である。

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